

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
20V	10mΩ@4.5V	7A

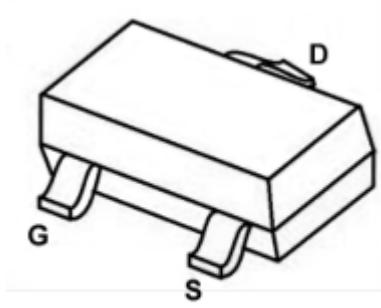
Feature

- 20V/7A,
- $R_{DS(ON)} = 10\text{m}\Omega(\text{Typ.}) @ V_{GS} = 4.5\text{V}$
 $R_{DS(ON)} = 13\text{m}\Omega(\text{Typ.}) @ V_{GS} = 2.5\text{V}$
- Low $R_{DS(ON)}$
- Super High Dense Cell Design
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Applications

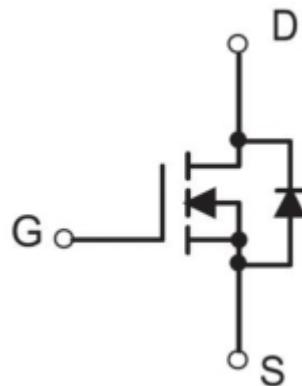
- Power Management

Package

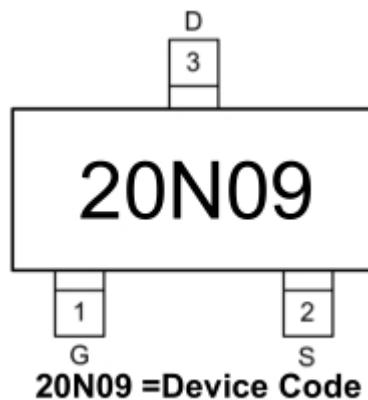


SOT-23-3L

Circuit diagram



Marking



Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D	7	A
Pulsed Drain Current	I_{DM}	28	A
Maximum Power Dissipation	P_D	1.25	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C

Electrical characteristics

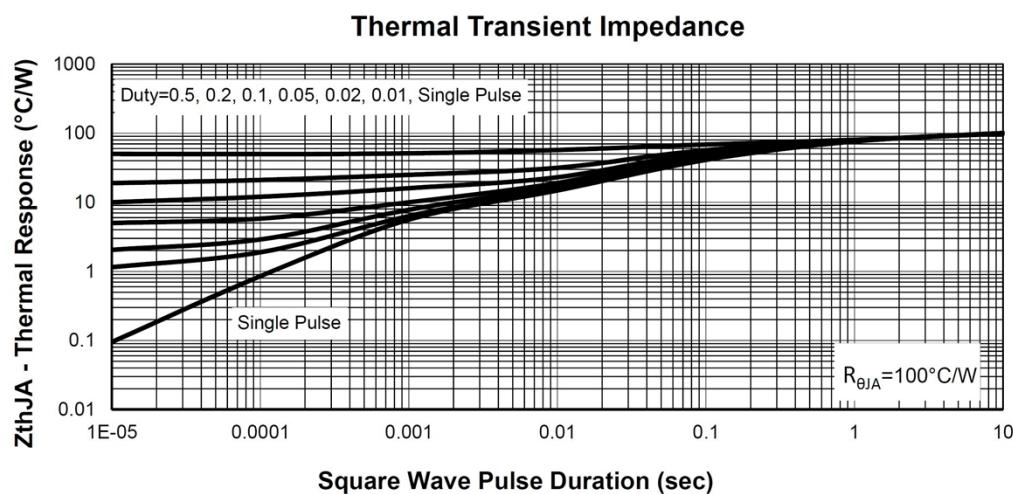
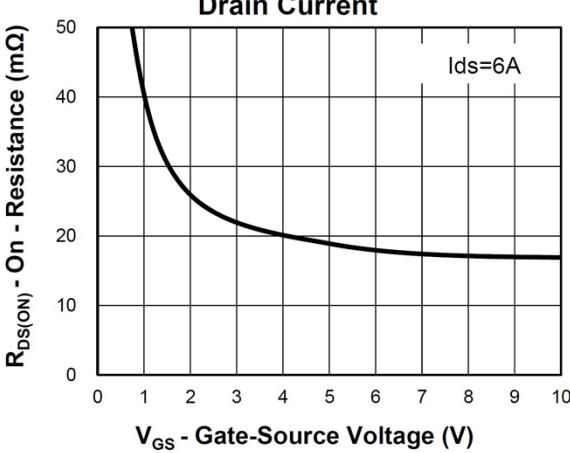
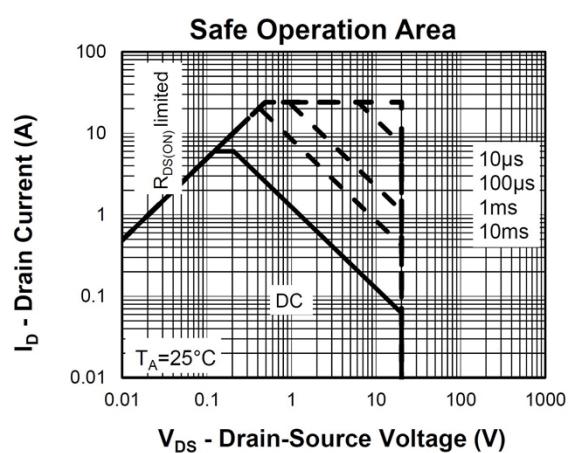
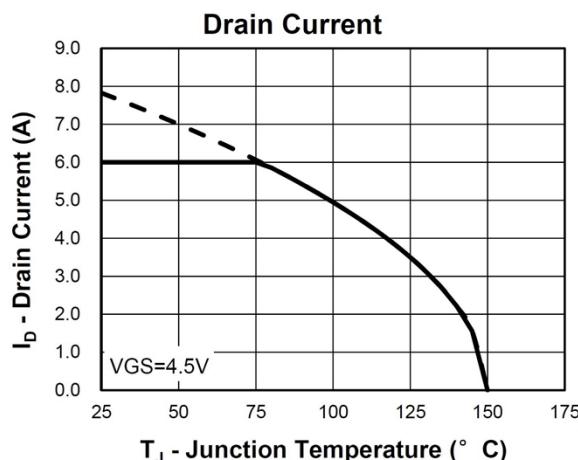
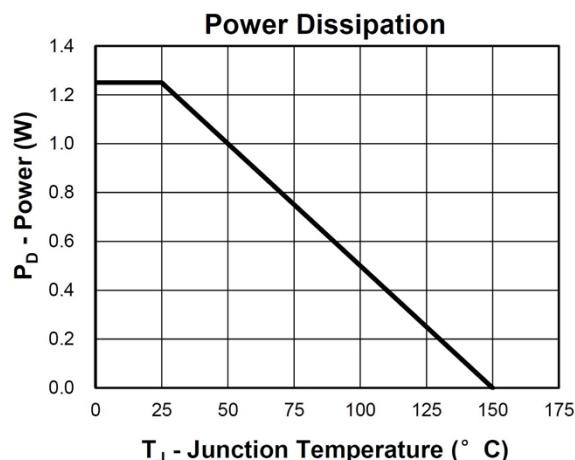
($T_A=25^\circ\text{C}$, unless otherwise noted)

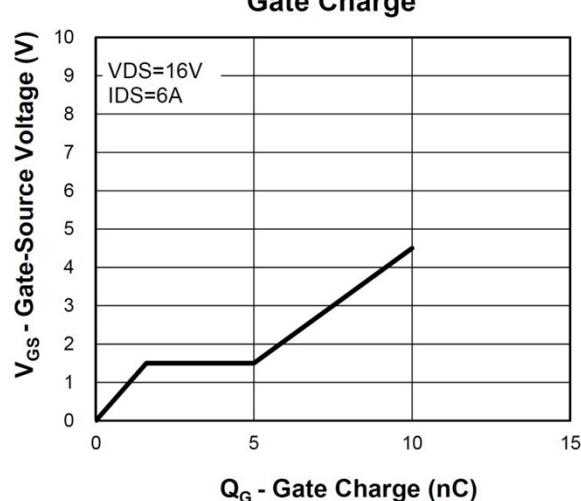
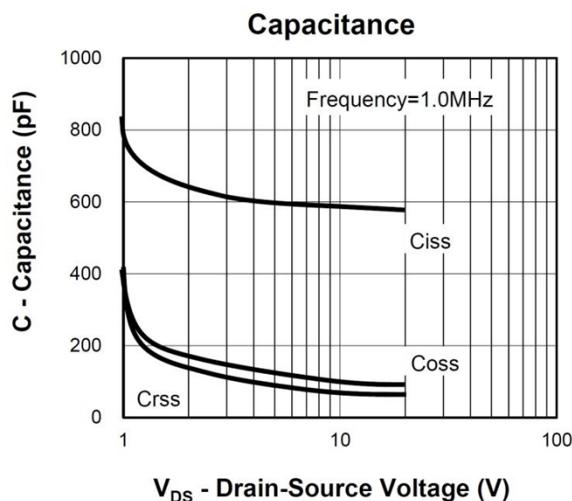
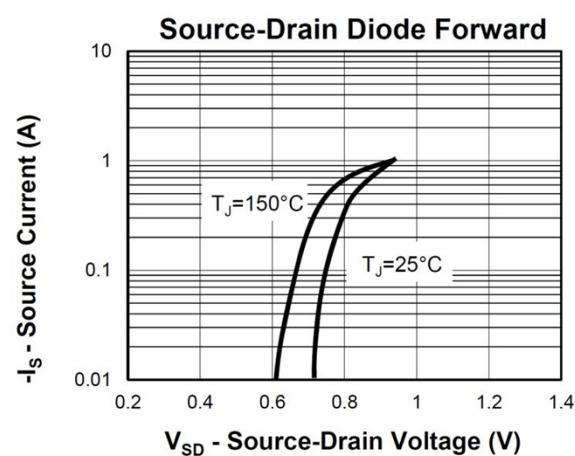
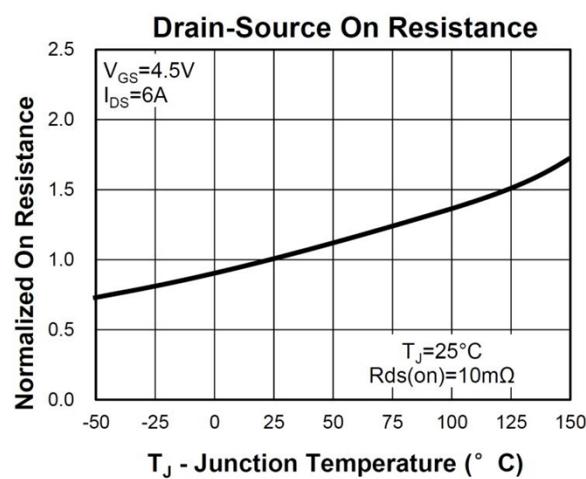
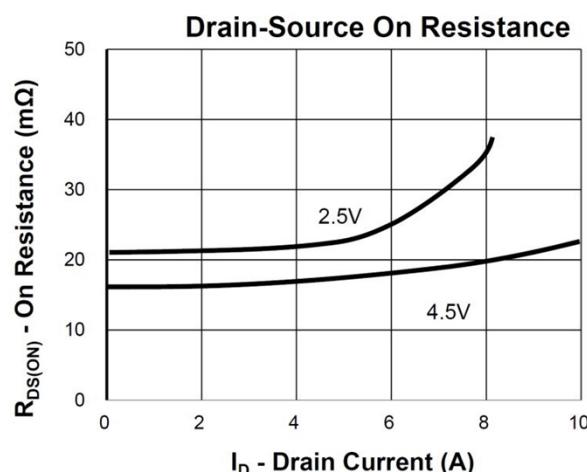
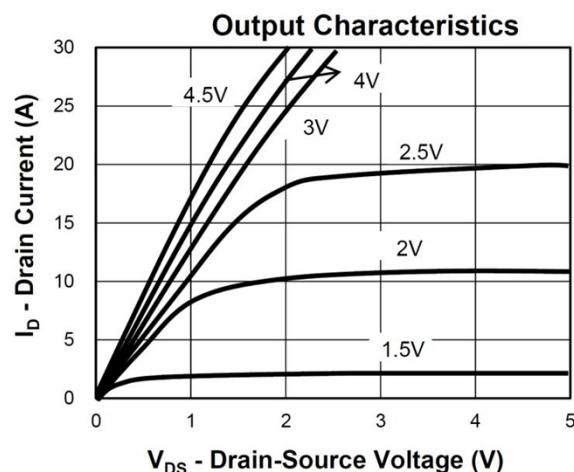
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	20			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 12\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	μA
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	0.5	0.7	1.5	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 4.5\text{V}, I_{\text{D}} = 6\text{A}$ $V_{\text{GS}} = 2.5\text{V}, I_{\text{D}} = 5\text{A}$		10	13	$\text{m}\Omega$
				13	18	
Dynamic characteristics ⁽²⁾						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		900		pF
Output Capacitance	C_{oss}			162		
Reverse Transfer Capacitance	C_{rss}			105		
Switching Characteristics ⁽²⁾						
Turn-On Delay Time	$T_{\text{d(on)}}$	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 10\text{V}, R_{\text{L}} = 0.5\Omega, R_{\text{GEN}} = 3\Omega$		4.5		nS
Rise Time	T_{r}			9.2		
Turn-Off Delay Time	$T_{\text{d(off)}}$			18.7		
Fall Time	T_{f}			3.3		
Total Gate Charge(4.5V)	Q_{g}	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 10\text{V}, I_{\text{D}} = 20\text{A}$		15		nC
Gate-Source Charge	Q_{gs}			1.8		
Gate-Drain Charge	Q_{gd}			2.8		
Drain-Source Diode Characteristics						
Diode Forward Voltage ⁽³⁾	V_{SD}	$I_{\text{s}} = 1\text{A}, V_{\text{GS}} = 0\text{V}$			1.2	V

Notes:

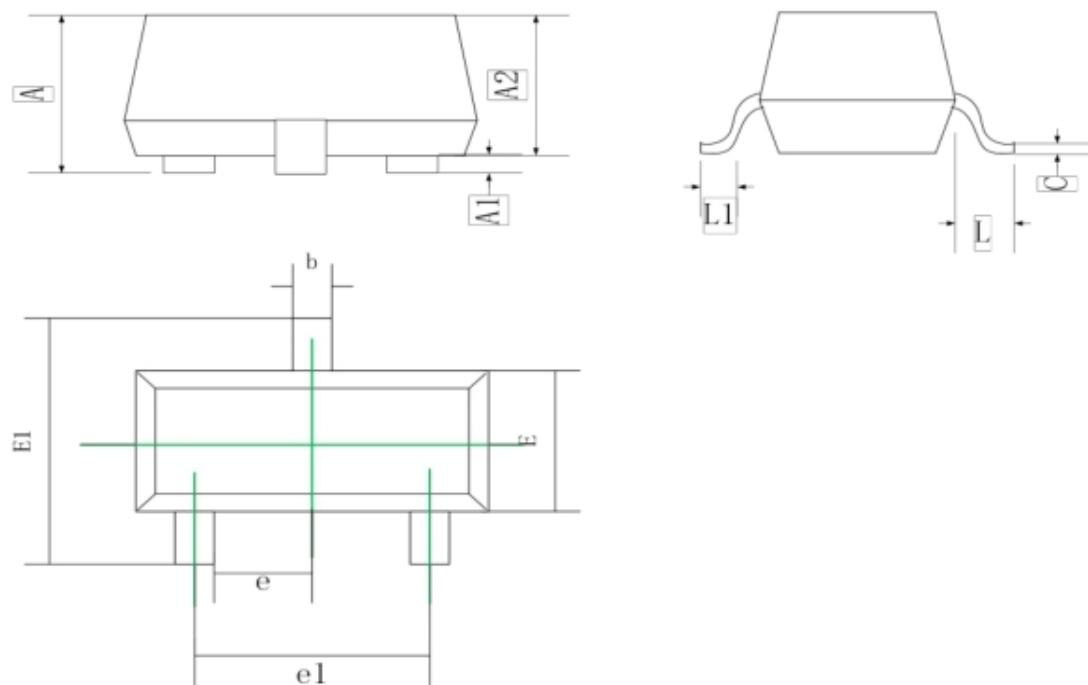
1. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
2. Guaranteed by design, not subject to production

Typical Characteristics





SOT-23-3L Package Information



Symbol	Dimensions in millimeters	
	Min.	Max.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950 Typ.	
e1	1.800	2.000
L	0.300	0.600
θ	0°	8°